1. Product profile

1.1 General description

Ultrafast power diode in a SOD141 (DO-201AD) axial lead plastic package.

1.2 Features and benefits

- Axial leaded plastic package
- Fast switching
- High voltage capability
- Low forward voltage drop
- Low leakage current
- Low thermal resistance
- Soft recovery characteristic

1.3 Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- High frequency switched-mode power supplies

1.4 Quick reference data

Table 1. Qui	ick reference data						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V _{RRM}	repetitive peak reverse voltage			-	-	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; Fig. 1; Fig. 2		-	-	4	A
Static characteristics							
V _F	forward voltage	I _F = 3 A; T _j = 150 °C; <u>Fig. 4</u>		-	0.82	1.05	V
Dynamic char	acteristics	·				1	
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Ramp Recovery; Fig. 5}$		-	-	75	ns
		$I_R = 1 \text{ A}; I_F = 0.5 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ Step Recovery}; Fig. 6$		-	-	50	ns





2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	k a	K A
2	А	anode	DO-201AD (SOD141)	001aaa020

3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
NUR460P	DO-201AD	Hermetically sealed plastic package; axial leaded; 2 leads	SOD141			
NUR460P/L01	DO-201AD	Hermetically sealed plastic package; axial leaded; 2 leads	SOD141			
NUR460P/L02	DO-201AD	Hermetically sealed plastic package; axial leaded; 2 leads	SOD141			
NUR460P/L03	DO-201AD	Hermetically sealed plastic package; axial leaded; 2 leads	SOD141			
NUR460P/L04	DO-201AD	Hermetically sealed plastic package; axial leaded; 2 leads	SOD141			

4. Limiting values

Table 4.Limiting values

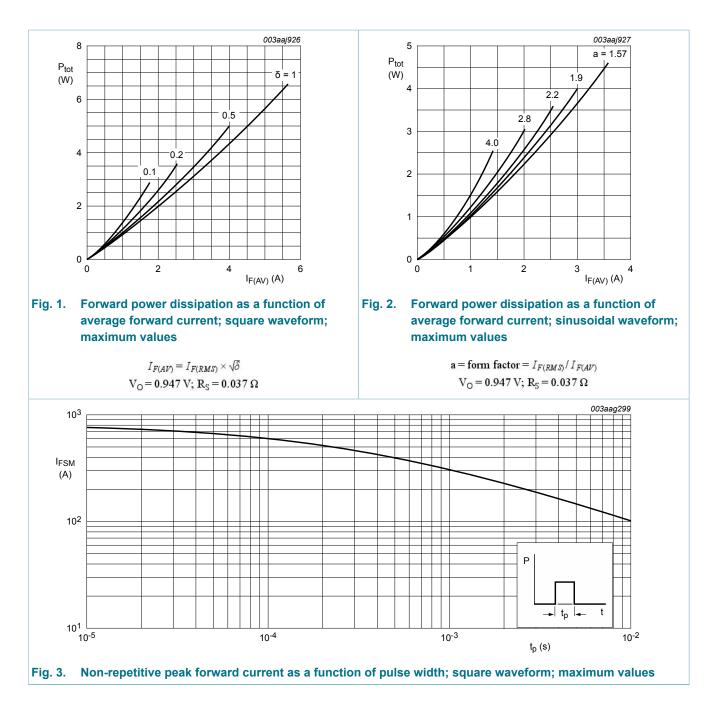
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{RRM}	repetitive peak reverse voltage		-	600	V
V _{RWM}	crest working reverse voltage		-	600	V
V _R	reverse voltage	DC	-	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; <u>Fig. 1</u> ; Fig. 2	-	4	А
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; square-wave pulse	-	8	А
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 3	-	100	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 3	-	110	А
T _{stg}	storage temperature		-65	175	°C
Tj	junction temperature		-	175	°C

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NUR460P Ultrafast power diode



5. Thermal characteristics

Table 5. The	5. Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		-	55	-	K/W

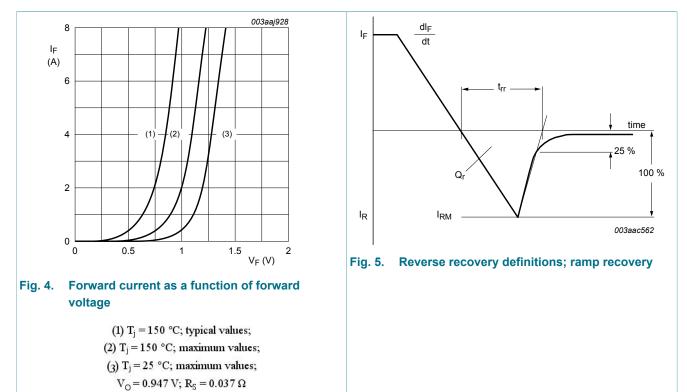
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Ultrafast power diode

6. Characteristics

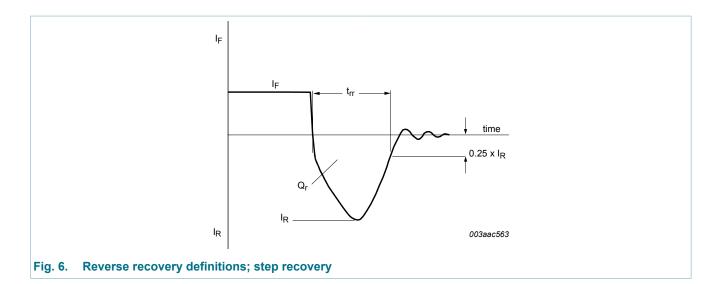
Table 6. Cha	racteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Static charact	eristics		·				
V _F	forward voltage	I _F = 3 A; T _j = 25 °C; <u>Fig. 4</u>		-	-	1.25	V
		I _F = 3 A; T _j = 150 °C; <u>Fig. 4</u>		-	0.82	1.05	V
		I _F = 4 A; T _j = 25 °C; <u>Fig. 4</u>		-	-	1.28	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C		-	-	10	μA
		V _R = 600 V; T _j = 150 °C		-	-	250	μA
Dynamic char	acteristics	1	1	1	1		
t _{rr}	reverse recovery time	I_F = 1 A; V_R = 30 V; dI_F/dt = 50 A/µs; T _j = 25 °C; Ramp Recovery; Fig. 5		-	-	75	ns
		$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ Step Recovery; } Fig. 6$		-	-	50	ns



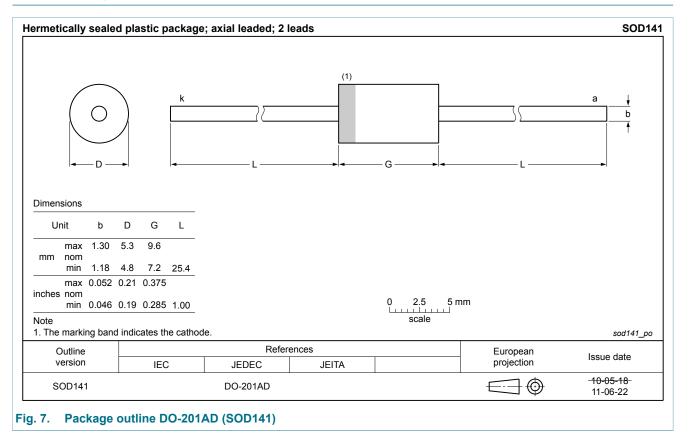
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7. Package outline



Ultrafast power diode

8. Legal information

8.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nxp.com</u>.

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9. Contents

1	Product profile	1
1.1	General description	1
1.2	Features and benefits	1
1.3	Applications	1
1.4	Quick reference data	1
2	Pinning information	2
3	Ordering information	2
4	Limiting values	2
5	Thermal characteristics	3
6	Characteristics	4
7	Package outline	5
8	Legal information	6
8.1	Data sheet status	6
8.2	Definitions	6
8.3	Disclaimers	6
8.4	Trademarks	7

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NUR460P